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Form PTO-1595 (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008) 03-27-2007



03/13/2007 U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

ARE I			
To the Director of the U.S. Pats 10338783	6 ched documents or the new address(es) below.		
1. Name of conveying party(ies):	2. Name and address of receiving party(les)		
Noboru Koyama (3-6-07); Tetsuya Hoshino (3-6-			
07)			
Additional name(s) of conveying party(les) attached? Yes X No	Internal Address: Street Address:		
3. Nature of conveyance/Execution Date(s):	- Street Address.		
Execution Date(s): In parenthesis after inventors' name	1-7-1 Konan, Minato-ku Tokyo, Japan		
X Assignment Merger Change of Name	, 51,75,752,251		
Security Agreement Joint Research Agreement	City:		
Government Interest Assignment	State:		
Executive Order 9424, Confirmatory License	Country: Zip:		
Other	Additional name(s) & address(es) Yes X No attached?		
4. Application or patent number(s):	This document is being filed together with a new application.		
A. Patent Application No.(s)	B. Patent No.(s)		
	11/717073		
Additional numbers attached? Yes XNo			
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:		
Name: Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00		
Internal Address: Atty. Dkt.: SON-3731	Authorized to be charged by credit card		
Street Address: 1233 20th Street, N.W.	Authorized to be charged to deposit account		
Suite 501	Enclosed		
	None required (government interest not affecting title)		
City: Washington	8. Payment Information		
State: DC Zip: 20036	a. Credit Card Last 4 Numbers		
Phone Number: (202) 955-3750	Expiration Date		
Fax Number: (202) 955-3751	b. Deposit Account Number 18-0013		
Email Address: rpk@raderfishman.com	Authorized User Name Ronald P. Kananen		
9. Signature:	4,230 March 13, 2007		
Signature O4404	Date		
Ronald P. Kananen -24,104  Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:		

03/26/2007 DBYRNE

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S07P0435US00 SON-3731

Docket	Number:	

		Docket Number:
	ASSIGNMENT	
WHEREAS, I, as a below na only one name is listed below) or a joint invent		s stated next to my name, am a sole inventor (i) of certain new and useful improvements in
	7709	
for which application for Letters Patent of the U	nited States of America was execute	ed by me on the date indicated next to my name
AND WHEREAS, Sony Con Tokyo, Japan (hereinafter referenced as ASSIGN said application disclosing the invention and in, therefor in the United States and in any and all	EE) is desirous of acquiring all intere , to and under any Letters Patent or	
the receipt and sufficience of which are hereby assign, sell and transfer unto the said AS interest in the said invention, said application, it Patent of the United States, and countries foreign rights and/or convention rights under the International Relating to Patents, Designs and Industrial Mod adheres, and to any other benefits accruing or to patents in the United States and countries foreign said United States Letters Patent to said ASSIGN And I further agree to execute all necessity.	scknowledged, I, as a sole or joint in SIGNEE, its successors, assigns, and neluding any divisions and continuat thereto, which may be granted for so onal Convention for the Protection of els, and any other international agreed accrue to the with respect to the fithereto, and I hereby authorize and reflect, as the assignee of the whole rights are desirable and lawful future	legal representatives, the entire right, title and tions thereof, and in and to any and all Letters aid invention, and in and to any and all priority. Industrial Property, Inter-American Convention ements to which the United States of America illing of applications for patents or securing of equest the Commissioner of Patents to issue the ght, title and interest thereto;  documents, including assignments in favor of
ASSIGNEE or its designee, as ASSIGNEE or its and without further remuneration, in order to pay applications and Letters Patent of the United States	erfect title in said invention, modifi	entatives may from time-to-time present to me ications, and improvements in said invention,
And I further agree to properly execute a papers for application for foreign patents, for filiteissues of any Letters Patent which may be grant prepare at its own expense;	ng subdivisions of said application f	neration, such necessary or desirable and lawful for patent, and or, for obtaining any reissue or ASSIGNEE thereof shall hereafter require and
And I further agree that ASSIGNEE will relating to said application, said invention and saucessible to me and will testify as to the same in	id Letters Patent and legal equivaler	omptly with all pertinent facts and documents nts in foreign countries as may be known and thereto;
And I hereby covenant that no assignment would conflict with this assignment and sale.	it, sale, agreement or encumbrance h	as been or will be made or entered into which
And I hereby authorize and request my at his application in the spaces that follow: Serial i	torney(s) of record in this application	n to insert the serial number and filing date of filing Date:
This assignment executed on the dates in	dicated below.	
Noboru KOYAMA		morph. L. 2007
ame of first or sole inventor		Execution date of U.S. Patent Application
Tokyo, Japan		•
esidence of first or sale inventor		<del></del>
		24.16 2-7
gnature of first or sole inventor		March 6. 2007  Date of this assignment
<del>-</del>	•	>110 OF 4113 marigination.

**PATENT** REEL: 019088 FRAME: 0774

S07P0435US00

Tetsuya HOSHINO	•	March 6, 2007 Execution date of U.S. Patent Application
Name of second inventor		Execution date of U.S. Patent Application
Tokyo, Japan	*	
Residence of second inventor		
	Tetago Naghino	March 6, 2007
Signature of second inventor	1.	Date of this assignment
		•
Name of third inventor		Execution date of U.S. Patent Application
Residence of third inventor		·
residence of third inventor		
Signature of third inventor		Date of this assignment
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Name of fourth inventor		Execution date of U.S. Patent Application
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Residence of fourth inventor		
Signature of fourth inventor		Date of this assignment
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6.501	<u> </u>	Execution date of U.S. Patent Application
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REEL: 019088 FRAME: 0775

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